

# Strengthening versus Softening of Nanotwinned Copper Depending on Prestress and Twin Spacing

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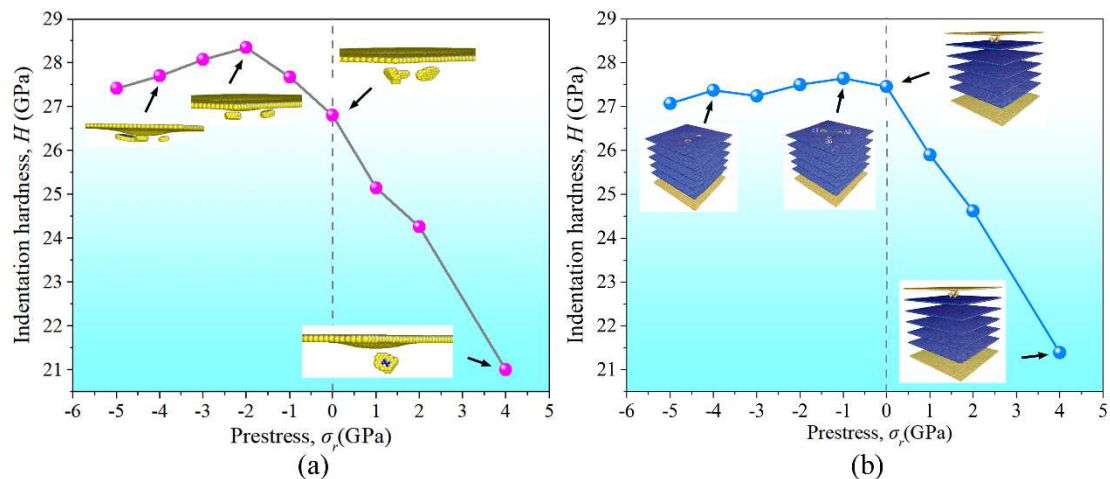
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**Figure S1.** The indentation hardness as a function of the prestress for sc-Cu (a) and nt-Cu with  $\lambda = 3.67$  nm (b). The inserts show the atomistic snapshots at initial load relaxation.